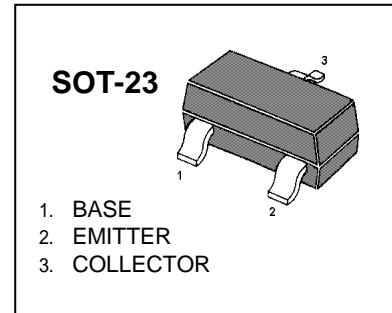


## Plastic-Encapsulate Transistors

### FEATURES

- Low collector-emitter saturation voltage
- High current capability
- Improved device reliability due to reduced heat generation

MARKING: ZF



Absolute Maximum Ratings Ta = 25°C

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	- 40	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	- 40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	- 5	V
I <sub>C</sub>	collector current (DC)		-	- 2	A
I <sub>CM</sub>	peak collector current		-	- 3	A
I <sub>BM</sub>	peak base current		-	- 300	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C ; note 1	-	300	mW
		T <sub>amb</sub> ≤ 25 °C ; note 2	-	480	mW
T <sub>stg</sub>	storage temperature		- 65	+150	°C
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		- 65	+150	°C

### Notes

1. Device mounted on a printed-circuit board, single sided copper, tin plated, standard footprint.
2. Device mounted on a printed-circuit board, single sided copper, tin plated, mounting pad for collector 1 cm<sup>2</sup>.

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air; note 1	417	K/W
		in free air; note 2	260	K/W

### Notes

1. Device mounted on a printed-circuit board, single sided copper, tin plated, standard footprint.
2. Device mounted on a printed-circuit board, single sided copper, tin plated, mounting pad for collector 1 cm<sup>2</sup>.

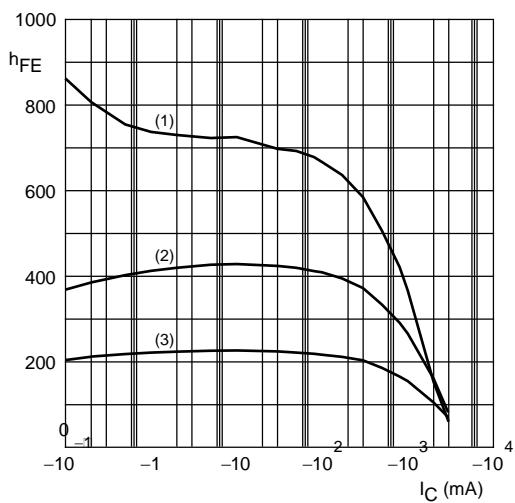
**CHARACTERISTICS**

$T_{amb} = 25 \text{ }^{\circ}\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0$	-	-	-100	nA
		$V_{CB} = -30 \text{ V}; I_E = 0; T_j = 150 \text{ }^{\circ}\text{C}$	-	-	-50	μA
$I_{BEO}$	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; I_C = 0$	-	-	-100	nA
$h_{FE}$	DC current gain	$V_{CE} = -2 \text{ V}$				
		$I_C = -100 \text{ mA}$	300	450	-	
		$I_C = -500 \text{ mA}$	260	350	-	
		$I_C = -1 \text{ A}$	210	290	-	
		$I_C = -2 \text{ A}$	100	180	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$	-	-55	-100	mV
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	-	-70	-110	mV
		$I_C = -750 \text{ mA}; I_B = -15 \text{ mA}$	-	-140	-225	mV
		$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	-	-140	-225	mV
		$I_C = -2 \text{ A}; I_B = -200 \text{ mA}$	-	-240	-350	mV
$R_{CEsat}$	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA};$ note 1	-	160	220	mΩ
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -2 \text{ A}; I_B = -200 \text{ mA}$	-	-	-1.1	V
$V_{BE(on)}$	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_C = -100 \text{ mA}$	-	-	-0.75	V
$f_T$	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -10 \text{ V};$ $f = 100 \text{ MHz}$	100	200	-	MHz
$C_c$	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0;$ $f = 1 \text{ MHz}$	-	23	28	pF

**Note**

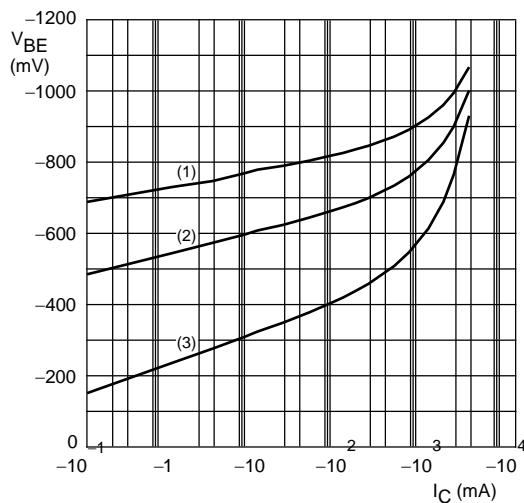
- Device mounted on a printed-circuit board, single sided copper, tin plated, standard footprint.

**Typical Characteristics**


$V_{CE} = -2 \text{ V}$ .

- (1)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .
- (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .
- (3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

Fig.1 DC current gain as a function of collector current; typical values.

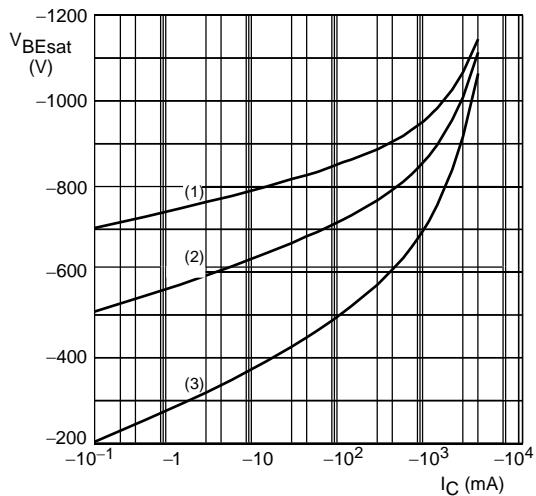


$V_{CE} = -2 \text{ V}$ .

- (1)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .
- (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .
- (3)  $T_{amb} = 150 \text{ }^{\circ}\text{C}$ .

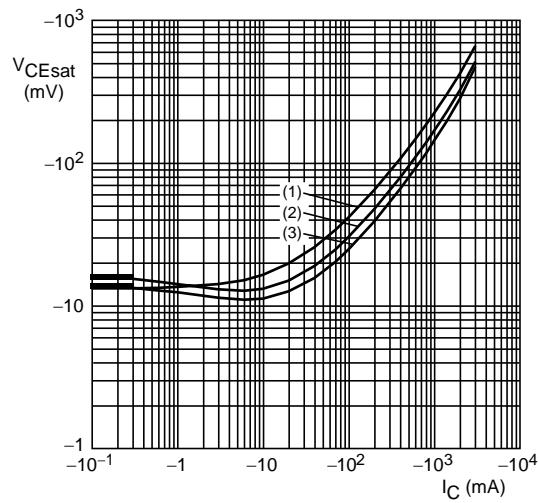
Fig.2 Base-emitter voltage as a function of collector current; typical values.

## Typical Characteristics



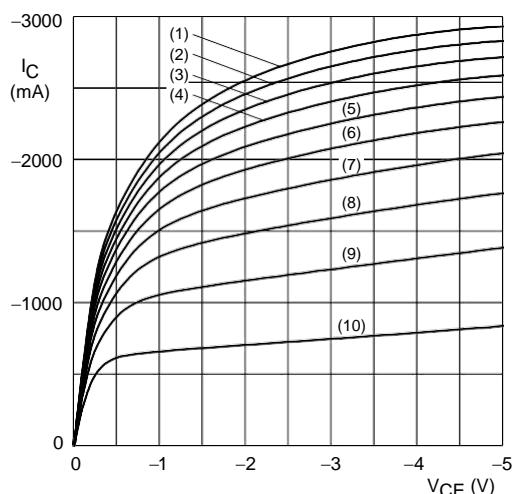
$I_C/I_B = 20$ .  
 (1)  $T_{amb} = -55^\circ\text{C}$ .  
 (2)  $T_{amb} = 25^\circ\text{C}$ .  
 (3)  $T_{amb} = 150^\circ\text{C}$ .

Fig.3 Base-emitter saturation voltage as a function of collector current; typical values.



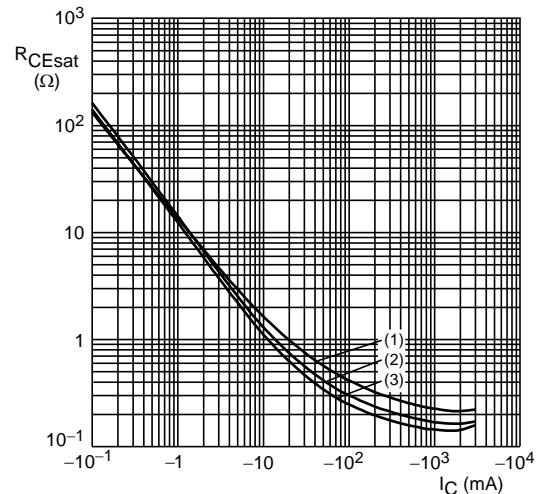
$I_C/I_B = 20$ .  
 (1)  $T_{amb} = 150^\circ\text{C}$ .  
 (2)  $T_{amb} = 25^\circ\text{C}$ .  
 (3)  $T_{amb} = -55^\circ\text{C}$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



(1)  $I_B = -23.0$  mA.  
 (2)  $I_B = -20.7$  mA.  
 (3)  $I_B = -18.4$  mA.  
 (4)  $I_B = -16.1$  mA.  
 (5)  $I_B = -13.8$  mA.  
 (6)  $I_B = -11.5$  mA.  
 (7)  $I_B = -9.2$  mA.  
 (8)  $I_B = -6.9$  mA.  
 (9)  $I_B = -4.6$  mA.  
 (10)  $I_B = -2.3$  mA.

Fig.5 Collector current as a function of collector-emitter voltage; typical values.



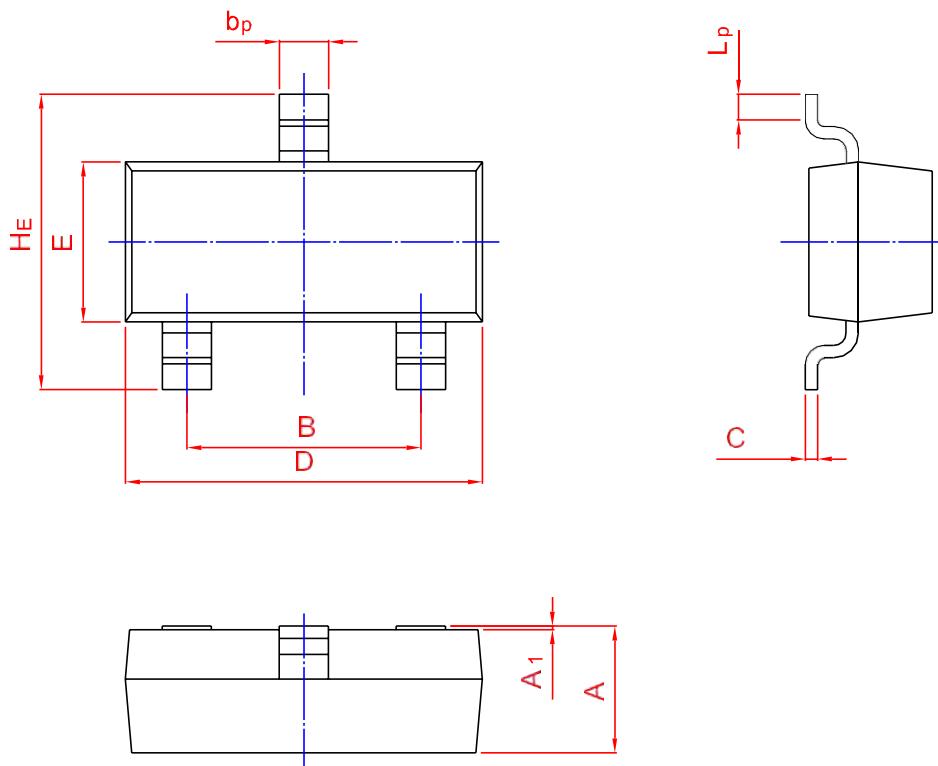
$I_C/I_B = 20$ .  
 (1)  $T_{amb} = 150^\circ\text{C}$ .  
 (2)  $T_{amb} = 25^\circ\text{C}$ .  
 (3)  $T_{amb} = -55^\circ\text{C}$ .

Fig.6 Equivalent on-resistance as a function of collector current; typical values.

## PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	b <sub>p</sub>	C	D	E	H <sub>E</sub>	A <sub>1</sub>	L <sub>p</sub>
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20